

NOT RECOMMENDED FOR NEW DESIGN USE DMP3021SFVWQ



DMP3018SFVQ

30V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI3333-8

Product Summary

BVDSS	Rds(on) Max	I _D Max T _C = +25°C
001/	12mΩ @ V _{GS} = -10V	-35A
-30V	21mΩ @ V _{GS} = -4.5V	-25A

Description

This MOSFET is designed to minimize the on-state resistance (R_{DS(ON)}) yet maintain superior switching performance, making it ideal for high-efficiency power management applications.

Applications

- Backlighting
- Power management functions
- DC-DC converters

Features and Benefits

- 100% Unclamped Inductive Switching (Test in Production) Ensures More Reliable and Robust End Application
- Low Rds(ON) ensures on-state losses are minimized
- Small form factor thermally efficient package enables higher density end products
- Occupies just 33% of the board area occupied by SO-8 enabling smaller end product
- ESD Protected Gate
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- The DIODES™ DMP3018SFVQ is suitable for automotive applications requiring specific change control; this part is AEC-Q101 qualified, PPAP capable, and manufactured in IATF 16949 certified facilities.

https://www.diodes.com/quality/product-definitions/

Mechanical Data

- Package: PowerDI[®]3333-8
- Package Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Connections Indicator: See Diagram
- Terminals: Finish Matte Tin Annealed over Copper Leadframe.
 Solderable per MIL-STD-202, Method 208 ③

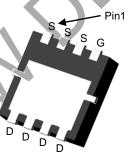
Weight: 0.03 grams (Approximate)



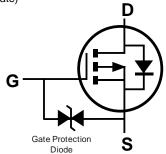


PowerDI3333-8 (Type UX)









Equivalent Circuit

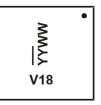
Ordering Information (Note 4)

Part Number		Paakaga	Packing		
		Package	Qty.	Carrier	
DMP3018SFVQ-7		PowerDI3333-8 (Type UX)	2,000	Tape & Reel	
DMP3018SFVQ-13		PowerDI3333-8 (Type UX)	3,000	Tape & Reel	

Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.
 See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



V18 = Product Type Marking Code

YYWW = Date Code Marking

YY = Last Two Digits of Year (ex: 22 = 2022)

WW = Week Code (01 to 53)



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit		
Drain-Source Voltage			VDSS	-30	V
Gate-Source Voltage			V_{GSS}	±25	V
Continuous Drain Current (Note 6) V _{GS} = -10V	Steady State	T _A = +25°C T _A = +70°C	lo	-11 -9	Α
Continuous Drain Current (Note 7) V _{GS} = -10V	Steady State	T _C = +25°C T _C = +70°C	lo	-35 -25	Α
Maximum Continuous Body Diode Forward Current (Note 7)			Is	-30	Α
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-70	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	-70	Α
Avalanche Current (Note 8) L = 1mH			las	-14	Α
Avalanche Energy (Note 8) L = 1mH			Eas	104	mJ

Thermal Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Total Power Dissipation (Note 5)	T _A = +25°C	PD	1.0	W
Thermal Resistance, Junction to Ambient (Note 5)	Steady State	Reja	133	°C/W
Total Power Dissipation (Note 6)	$T_A = +25^{\circ}C$	P _D	1.9	W
Thermal Resistance, Junction to Ambient (Note 6)	Steady State	Reja	66	°C/W
Total Power Dissipation (Note 7)		P _D	30	W
Thermal Resistance, Junction to Case (Note 7)		Rejc	3.7	°C/W
Operating and Storage Temperature Range		TJ, TSTG	-55 to +150	°C

Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

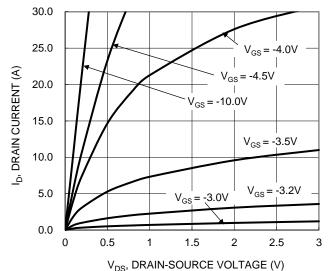
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)							
Drain-Source Breakdown Voltage	BV _{DSS}	-30			V	$V_{GS} = 0V$, $I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	I _{DSS}	J		-1	μΑ	$V_{DS} = -24V, V_{GS} = 0V$	
Gate-Source Leakage	Igss	7	-	±10	μΑ	$V_{GS} = \pm 20V$, $V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)							
Gate Threshold Voltage	Vgs(TH)	-1.0	_	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	Dayou			12	mΩ	V _{GS} = -10V, I _D = -11.5A	
Static Dialii-Source Off-Resistance	R _{DS(ON)}			21	11122	$V_{GS} = -4.5V$, $I_{D} = -8.5A$	
Diode Forward Voltage	VsD		-0.7	-1.2	V	$V_{GS} = 0V$, $I_{S} = -1A$	
DYNAMIC CHARACTERISTICS (Note 10)							
Input Capacitance	Ciss		2147		рF	\\ 45\\\\\ 0\\	
Output Capacitance	Coss		407		рF	$V_{DS} = -15V, V_{GS} = 0V,$ f = 1.0MHz	
Reverse Transfer Capacitance	Crss		358		рF		
Gate Resistance	Rg		24		Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1.0MHz$	
Total Gate Charge (VGS = -5V)	Qg	_	28	_	nC		
Total Gate Charge (V _{GS} = -10V)	Qg	_	51	_	nC V 45V L 44.5A		
Gate-Source Charge	Qgs		6.6		nC	$V_{DS} = -15V, I_{D} = -11.5A$	
Gate-Drain Charge	Q_{gd}		15		nC]	
Turn-On Delay Time	t _{D(ON)}		7.8		ns		
Turn-On Rise Time	t _R		19.9		ns	V _{DD} = -15V, V _{GS} = -10V,	
Turn-Off Delay Time	tD(OFF)	_	57.5	_	ns	ns $R_G = 6\Omega$, $I_D = -11.5A$	
Turn-Off Fall Time	tr		42.8		ns		
Reverse Recovery Time	trr	_	21.5	.5 — ns		1- 44 FA - 11/-14 - 400 A /	
Reverse Recovery Charge	Q _{RR}	_	11.6	_	nC	Is = -11.5A, dl/dt = 100A/µs	

5. Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.

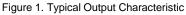
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with thermal bias to bottom layer 1-inch square copper plate.
 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep $T_J = +25^{\circ}C$.
- 9. Short duration pulse test used to minimize self-heating effect.
- 10. Guaranteed by design. Not subject to product testing.

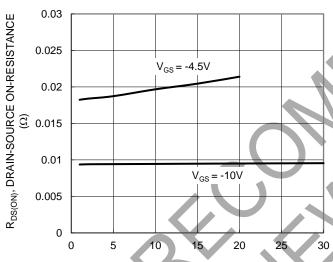






V_{DS}, DRAIN-SOURCE VOLTAGE (V)





I_D, DRAIN-SOURCE CURRENT (A)
Figure 3. Typical On-Resistance vs. Drain Current and
Gate Voltage

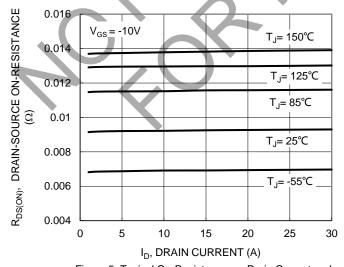
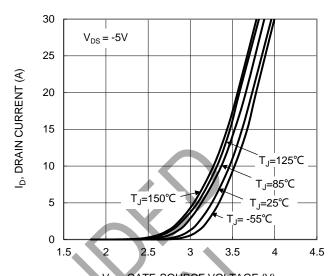


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



V_{GS}, GATE-SOURCE VOLTAGE (V) Figure 2.Typical Transfer Characteristic

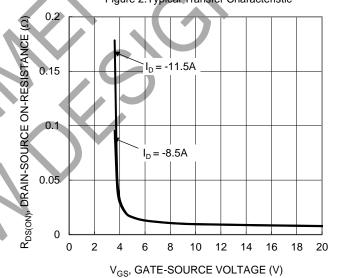


Figure 4. Typical Transfer Characteristic

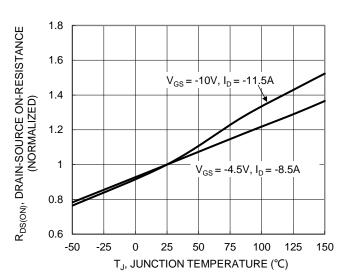


Figure 6. On-Resistance Variation with Junction Temperature





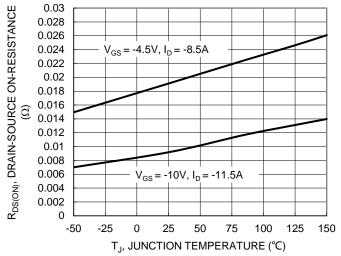
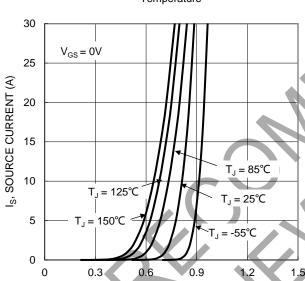


Figure 7. On-Resistance Variation with Junction Temperature



V_{SD}, SOURCE-DRAIN VOLTAGE (V) Figure 9. Diode Forward Voltage vs. Current

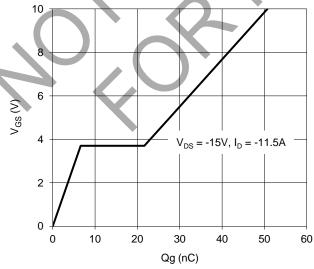


Figure 11.Gate Charge

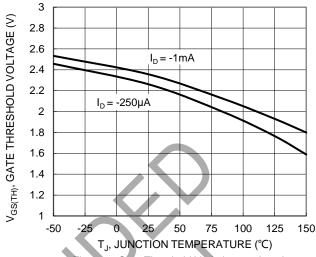


Figure 8. Gate Threshold Variation vs. Junction Temperature

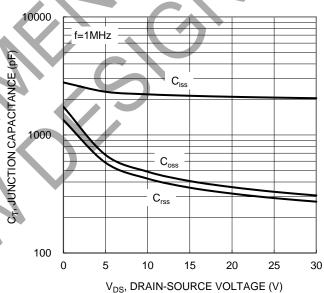
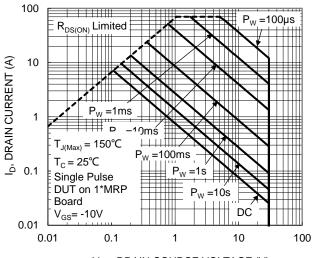


Figure 10. Typical Junction Capacitance



V_{DS}, DRAIN-SOURCE VOLTAGE (V) Figure 12. SOA, Safe Operation Area



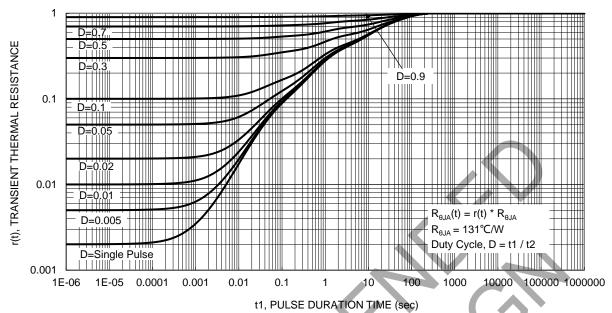


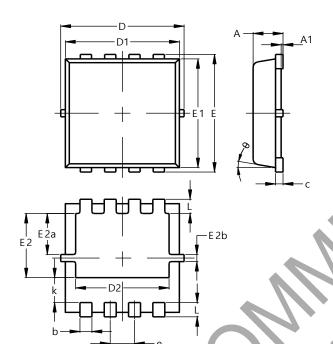
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)

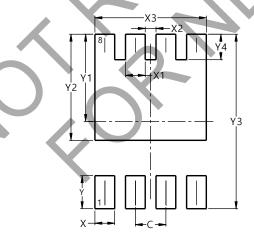


PowerDI3333-8 (Type UX)				
Dim	Min	Max	Тур	
Α	0.75	0.85	0.80	
A1	0.00	0.05		
b	0.25	0.40	0.32	
С	0.10	0.25	0.15	
D	3.20	3.40	3.30	
D1	2.95	3.15	3.05	
D2	2.30	2.70	2.50	
П	3.20	3.40	3.30	
E1	2.95	3.15	3.05	
E2	1.60	2.00	1.80	
E2a	0.95	1.35	1.15	
E2b	0.10	0.30	0.20	
е	0.65 BSC			
k	0.50	0.90	0.70	
1	0.30	0.50	0.40	
θ	0°	12°	10°	
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

PowerDI3333-8 (Type UX)



Dimensions	Value (in mm)			
С	0.650			
Х	0.420			
X1	0.420			
X2	0.230			
Х3	2.370			
Υ	0.700			
Y1	1.850			
Y2	2.250			
Y3	3.700			
Y4	0.540			



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